

International Conference on Mechanical Structures and Smart Materials (ICMSSM 2013)

Xiamen, China, Nov .16-17, 2013

◆ Introduction

Received supports and encourages from scholars, we are pleased to announce that 2013 International Conference on Mechanical Structures and Smart Materials is being organized and will be held on 16-17th November, 2013 in Xiamen, China.

ICMSSM 2013 aims at providing researchers, scientists, engineers and scholar students for presenting novel and fundamental advances in the fields of Mechanical Structures and Smart Materials. Authors are invited to contribute their papers, showcase their latest tools and techniques so as to promote the creation and exchange of ideas and the identification of new trends and required developments.

All accepted papers of ICMSSM 2013 will be published in "Applied Mechanics and Materials" [ISSN: 1660-9336, Trans Tech Publications].

◆ Submission

ICMSSM 2013 invites authors to submit original and unpublished work. Papers should cover 4 pages formatted according to the Template. All submitted papers should be written in English. Submission implies the willingness of at least one of the authors to register the work. Papers should be submitted to us by two ways:

(1) Easy chair Submission System: <http://www.easychair.org/conferences/?conf=icmssm2013>

(2) email: cfp@icmssm.org

◆ Topics

Topics of interest include, but are not limited to:

1. The mechanical structure and mechanical engineering
2. Materials Science and Engineering
3. Materials Manufacturing and Processing

◆ Deadline:

Paper Submission (Full Paper): Oct 9, 2013

Notification of Acceptance: Oct 16, 2013

Authors' Registration & Payment: Oct 23, 2013

Conference Date: Nov 16-17, 2013

◆ Contact

Email : cfp@icmssm.org

Web : <http://www.icmssm.org/>

Tel : +86-24-83958169-801 Ms.Ji

+86-24-83958379-811 Ms.Lin

Q Q : 2947191913

